Published in final edited form as:

Ultrasonics. 2013 February ; 53(2): 455–458. doi:10.1016/j.ultras.2012.08.013.

Improved fabrication of focused single element P(VDF–TrFE) transducer for high frequency ultrasound applications

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Abstract

We present an improved fabrication technique for the focused single element poly (vinylidene fluoride–trifluoroethylene) P(VDF–TrFE) transducer. In this work, a conductive epoxy for a backing layer was directly bonded to the 25 μm thick P(VDF–TrFE) film and thus made it easy to conform the aperture of the P(VDF–TrFE) transducer. Two prototype focused P(VDF–TrFE) transducers with disk- and ring-type aperture were fabricated and their performance was evaluated using the UBM (Ultrasound Biomicroscopy) system with a wire phantom. All transducers had a spherically focused aperture with a low f-number (focal depth/aperture size = 1). The center frequency of the disk-type P(VDF–TrFE) transducer was 23 MHz and –6 dB bandwidth was 102%. The ring-type P(VDF–TrFE) transducer had 20 MHz center frequency and –6 dB bandwidth of 103%. The measured pulse echo signal had reduced reverberation due to no additional adhesive layer between the P(VDF–TrFE) film and the backing layer. Hence, the proposed method is promising to fabricate a single element transducer using P(VDF–TrFE) film for high frequency applications.

Keywords

Transducer; P(VDF–TrFE) film; Conductive backing layer; High frequency applications

1. Introduction

An ultrasound transducer with broad bandwidth and high sensitivity has been becoming important for diagnostic ultrasound imaging. Typically, the performance of the ultrasound transducer depends on the property of the piezoelectric material capable of converting the electrical energy into mechanical energy, and vice versa. A single crystal and a piezoceramic material such as a lead zirconate titanate (PZT) have been frequently used for conventional diagnostic transducers [1]. Although aforementioned piezoelectric materials have high electromechanical coupling coefficients, they are suffered from narrow bandwidth, high acoustic impedance, and difficult aperture conformation [1,2].

In 1969, Kawaii discovered high piezoelectricity in PVDF (polyvinylidene fluoride) providing broad bandwidth, low acoustic impedance, and excellent mechanical flexibility

[3]. Although the electromechanical coefficient of PVDF was lower than piezoceramic materials, it has been successfully used for various ultrasound applications. More recently, the poly (vinylidene fluoride-trifluoroethylene) P(VDF-TrFE) called PVDF copolymer was developed [4-6]. Its higher electromechanical coefficient, lower electrical and mechanical loss compared to PVDF were allowed to make various types of P(VDF-TrFE) transducers including a linear or an annular array transducer [7-9]. The applications of P(VDF-TrFE) transducer have been expanded from hydrophone construction [10-14] to imaging of tissue microstructure such as dermatology, ophthalmology, biomicroscopy, and small animal applications because design parameters and operating conditions of the P(VDF-TrFE) transducer are suitable for high frequency range [15-20].

Although the P(VDF-TrFE) film is easy to handle, achieving focused aperture using P(VDF-TrFE) film is very challengeable. Most fabrication processes require an additional adhesive layer between P(VDF-TrFE) film and backing materials and thus may result in high amplitude of reverberation in pulse echo signals [21-23]. Recently, PVDF spin coating technique has been developed instead of P(VDF-TrFE) film, however, it needs special equipments and complicated process [24,25]. In this paper, we present an improved fabrication technique for the focused single element transducer by using P(VDF-TrFE) film and conductive epoxy. The disk- and ring-type P(VDF-TrFE) transducers with highly focused aperture were successfully built and their performance was evaluated.

2. Methods

2.1. Transducer fabrication

The fabrication procedure for a ring-type transducer is divided into two major stages: making a disk-type transducer and subsequently making a cylindrical hole in the center of the aperture. As a piezoelectric material, we used 25 μm thick P(VDF-TrFE) film (Ktech Corporation, Albuquerque, NM) whose resonance frequency is 24 MHz at $\lambda/4$ resonance with a heavy backing layer [20]. For a conductive backing layer, silver epoxy (ESOLDER 3022, Von. Roll Isola, Inc., New Haven, CT) was directly added on P(VDF-TrFE) film with gold electrode. Note that the plasma cleaning job was done before adding silver epoxy for more stronger adhesion force between P(VDF-TrFE) film and the backing layer. After using the centrifuge machine and overnight curing, the P(VDF-TrFE)-backing stack was trimmed off by using the lathe machine in order to obtain the desired aperture size of 13.5 mm. Subsequently, it was assembled with a brass housing and filled with unloaded epoxy (EPOTEK 301, Epoxy Technology, Billerica, MA) for insulation between the housing and the electrode of the backing layer. After overnight curing, we can make a hole with 8 mm diameter using the lathe machine for the ring-type transducer. Another brass housing was inserted inside of the hole. In the case of a disk-type transducer, hole making process was omitted. For conformation of the focused aperture, the stainless steel ball with 27 mm diameter was mounted on the front side of the transducer and pressed focused at 70 °C in the oven during short time, i.e., less than 5 min. The electrode wire was used to connect the conductive backing layer and the SMA (Subminiature version A) type connector assembled with the housing. Finally, 0.5 μm thick gold/chrome electrode was sputtered on the front side of the transducer for ground electrode between P(VDF-TrFE) and the housing.

Table 1 describes the properties for P(VDF-TrFE) and Table 2 shows the measured performance of the prototype transducer. Fig. 1a and b shows the photography of the disk- and ring-type P(VDF-TrFE) transducers and Fig. 1c shows a cross-sectional schematic diagram of the ring-type P(VDF-TrFE) transducer. They have spherically focused aperture and no matching layer.

2.2. Experimental setup for B-mode imaging

Fig. 2 shows the schematic diagram of the single-channel UBM (Ultrasound biomicroscopy) system for high frequency 2-dimensional (2D) B-mode imaging. The B-mode images were obtained from the linear mechanical scanning and the target was a wire phantom with five wires. The diameter of each wire was 20 μm and made from tungsten. The UBM system was composed of several components. A linear motor controlled by a servo controller (LAR37, SMAC Inc., Carlsbad, CA, USA) and trigger generator (33250A, Agilent, Santa Clara, CA) was operated in swept mode in order to obtain multiple scanlines. For imaging, a function generator (33250A, Agilent, Santa Clara, CA) was connected to a power amplifier (325LA, ENI Co., Santa Clara, CA) with a 50 dB gain. A diode expander (DEX-3, Matec, Northborough, MA) and limiter (DL-1, Matec, Northborough, MA) were used to protect the electrical equipment. The received pulse echo signal was amplified by a receiver (5900PR, Panametrics Inc., Waltham, MA) and the received data was digitized by a 12 bit ADC (Analog to Digital Converter) (CS12400, Gage Applied Technologies Inc., Lachine, QC, Canada) controlled by LabVIEW program (LabVIEW, National instruments Co., Austin, TX). After obtaining radio frequency raw data, envelope detection and logarithmical compression were conducted using Matlab (The MathWorks Inc., Natick, MA) program.

3. Results

3.1. Pulse echo and impedance test

The pulse echo test and the electrical impedance measurement for the prototype transducers were conducted. As shown in Fig. 3, the center frequency of the disk-type transducer was 23 MHz and the -6 dB bandwidth was 102%. For a ring-type transducer, the center frequency was 20 MHz and the -6 dB bandwidth was 103%. Fig. 4 shows the measured electrical impedance of the water-loaded prototype transducers by using an impedance analyzer (4294A Impedance Analyzer, Agilent, Santa Clara, CA). At 23 MHz and 20 MHz, the impedances of disk- and ring-type transducers were 120 Ω and 70 Ω , respectively. Since the aperture size, the thickness of the backing layer, and the length of the electrode wire of the two transducers are different, the pulse echo and the impedance plots of the prototype transducers are not identical. Also, the phase resonance at 45 MHz in Fig. 4a may be due to the aforementioned factors.

3.2. B-mode imaging test

Fig. 5a and b shows the experimental 2D B-mode images of the disk- and ring-type transducers. The focal depths for disk- and ring-type transducers were 9.4 mm and 13.5 mm, respectively. The distance between wires was approximately 1.5 mm. The high sidelobe level of the wires in Fig. 5b was due to the property of the ring-type transducer, i.e., a ring-type transducer generates higher sidelobe level compared to a disk-type transducer [27]. All figures were logarithmically compressed with a dynamic range of 50 dB.

4. Conclusions

In this paper, we proposed a modified fabrication scheme for the high frequency single element transducer using P(VDF-TrFE) film. The focused disk- and ring-type P(VDF-TrFE) transducers were successfully fabricated and their performance was evaluated using the UBM system. The center frequencies and the -6 dB bandwidths of disk- and ring-type transducers were more than 20 MHz and 100%, respectively. In this scheme, the conductive backing layer was directly bonded to the P(VDF-TrFE) film without additional adhesive layer. The conductive backing layer after curing can make it easy to form the highly focused aperture with low f -number ($f_{\text{number}} = 1$). Additionally, it can be used for creating any surface geometry such as disk- and ring-type aperture. Hence, the P(VDF-TrFE) transducer

fabricated by the proposed method can be applied various types of high frequency transducers and thus used for high frequency applications.

Acknowledgments

This research was supported by Basic Science Research Program through the National Research Foundation of Korea (NRF) funded by the Ministry of Education, Science and Technology (2012R1A1A1044159).

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Fig. 1. Photographs of the prototype (a) disk- and (b) ring-type P(VDF-TrFE) transducers. (c) A cross sectional schematic diagram of the ring-type P(VDF-TrFE) transducer. Note that the photography (a) and (b) shows the aperture before chrome/gold sputtering for the ground electrode.

Fig. 2. Schematic diagram of the single-channel UBM system for high frequency 2D B-mode imaging of the single element transducer (ring-type transducer).

Fig. 3.
Experimental pulse echo results of the disk-type (a) and ring-type (b) P(VDF-TrFE) transducers.

Fig. 4. Electrical impedance and phase of the disk-type (a) and ring-type (b) P(VDF-TrFE) transducers.

Fig. 5. Sectional scan (B-mode) of the wire phantom for the prototype (a) disk- and (b) ring-type P(VDF-TrFE) transducers.

Table 1

Material properties for P(VDF-TrFE) [9,26].

Property	Value
Density (ρ)	1880 kg/m ³
Longitudinal wave velocity (v_l)	2280 m/s
Acoustic impedance (Z_A)	4.3 Mrayl
Piezoelectric strain constant (d_{31})	12 pC/N
Electromechanical coupling coefficient (k_t)	0.3
Relative dielectric permittivity (ϵ_r/ϵ_0)	5
Electrical loss tangent ($\tan \delta_e$)	0.12
Mechanical loss tangent ($\tan \delta_m$)	0.04

Table 2

Measured performance of the prototype P(VDF-TrFE) transducers.

	Disk-type	Ring-type
Center frequency (MHz)	23	20
-6 dB Bandwidth (%)	102	103
P(VDF-TrFE) thickness (μm)	25	25
Focal depth (mm)	9.4	13.5
Inner diameter (mm)	-	8
Outer diameter (mm)	9.4	13.5
F-number	1	1
Electrical impedance (Ohms)	120	70